IGBT - Field Stop, Trench
650 V, 60 A

FGH60T65SQD-F155

Description

Using novel field stop IGBT technology, ON Semiconductor's new series of field stop 4th generation IGBTs offer the optimum performance for solar inverter, UPS, welder, telecom, ESS and PFC applications where low conduction and switching losses are essential.

Features

- Max Junction Temperature 175°C
- Positive Temperature Co−efficient for Easy Parallel Operating
- High Current Capability
- Low Saturation Voltage: $V_{CE(sat)}$ = 1.6 V (Typ.) @ I_C = 60 A
- 100% of the Parts Tested for ILM(1)
- High Input Impedance
- Fast Switching
- Tighten Parameter Distribution
- This Device is Pb−Free and is RoHS Compliant

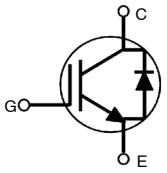
Applications

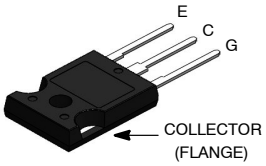
- Solar Inverter, UPS, Welder, Telecom, ESS, PFC

ON Semiconductor®

www.onsemi.com

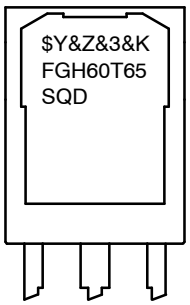
V_{CES}	I_C
650 V	60 A





TO−247−3LD
CASE 340CH

MARKING DIAGRAM



$Y	= ON Semiconductor Logo
&Z	= Assembly Plant Code
&3	= Numeric Date Code
&K	= Lot Code
FGH60T65SQD	= Specific Device Code

ORDERING INFORMATION

See detailed ordering and shipping information on page 2 of this data sheet.

ABSOLUTE MAXIMUM RATINGS

Symbol	Description		FGH60T65SQD−F155	Unit
V_{CES}	Collector to Emitter Voltage		650	V
V_{GES}	Gate to Emitter Voltage		±20	V
	Transient Gate to Emitter Voltage		±30	V
I_C	Collector Current	@ Tc < 25°C	120	A
		@ Tc < 100°C	60	
I_{LM} (Note 1)	Pulsed Collector Current	@ Tc < 25°C	240	A
I_{CM} (Note 2)	Pulsed Collector Current		240	A
I_F	Diode Forward Current	@ Tc < 25°C	60	A
	Diode Forward Current	@ Tc < 100°C	30	A
I_{FM} (Note 2)	Repetitive Forward Surge Current		240	A
P_D	Maximum Power Dissipation	@ Tc < 25°C	333	W
		@ Tc < 100°C	167	W
T_J	Operating Junction Temperature Range		−55 to +175	°C
T_{STG}	Storage Temperature Range		−55 to +175	°C
T_L	Maximum Lead Temp. For soldering Purposes, 18” from case for 5 sec		300	°C

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

1. V_{CC} = 400 V, V_{GE} = 15 V, I_C = 240 A, R_G = 21 Ω, Inductive Load.
2. Repetitive rating: Pulse width limited by max. junction temperature.

THERMAL CHARACTERISTICS

Symbol	Parameter	FGH60T65SQD−F155	Unit
$R_{\theta JC}$ (IGBT)	Thermal Resistance, Junction to Case, Max.	0.45	°C/W
$R_{\theta JC}$ (Diode)	Thermal Resistance, Junction to Case, Max.	1.25	°C/W
$R_{\theta JA}$	Thermal Resistance, Junction to Ambient, Max.	40	°C/W

PACKAGE MARKING AND ORDERING INFORMATION

Part Number	Top Mark	Package	Packing Method	Reel Size	Tape Width	Quantity
FGH60T65SQD−F155	FGH60T65SQD	TO−247−3LD	Tube	−	−	30

ELECTRICAL CHARACTERISTICS OF THE IGBT (T_C = 25°C unless otherwise noted)

Symbol	Parameter	Test Conditions	Min	Typ	Max	Unit
OFF CHARACTERISTICS						
BV_{CES}	Collector to Emitter Breakdown Voltage	V_{GE} = 0 V, I_C = 1 mA	650	–	–	V
$\Delta BV_{CES} / \Delta T_J$	Temperature Coefficient of Breakdown Voltage	I_C = 1 mA, Reference to 25°C	–	0.6	–	V/°C
I_{CES}	Collector Cut−Off Current	V_{CE} = V_{CES}, V_{GE} = 0 V	–	–	250	μA
I_{GES}	G−E Leakage Current	V_{GE} = V_{GES}, V_{CE} = 0 V	–	–	±400	nA
ON CHARACTERISTICS						
$V_{GE(th)}$	G−E Threshold Voltage	I_C = 60 mA, V_{CE} = V_{GE}	2.6	4.5	6.4	V
$V_{CE(sat)}$	Collector to Emitter Saturation Voltage	I_C = 60 A, V_{GE} = 15 V	–	1.6	2.1	V
		I_C = 60 A, V_{GE} = 15 V, T_C = 175°C	–	1.92	–	V
DYNAMIC CHARACTERISTICS						
C_{ies}	Input Capacitance	V_{CE} = 30 V, V_{GE} = 0 V, f = 1MHz	–	3813	–	pF
C_{oes}	Output Capacitance		–	90	–	pF
C_{res}	Reverse Transfer Capacitance		–	13	–	pF
SWITCHING CHARACTERISTICS						
$t_{d(on)}$	Turn−On Delay Time	V_{CC} = 400 V, I_C = 15 A, R_G = 4.7 Ω, V_{GE} = 15 V, Inductive Load, T_C = 25°C	–	20.8	–	ns
t_r	Rise Time		–	8	–	ns
$t_{d(off)}$	Turn−Off Delay Time		–	102	–	ns
t_f	Fall Time		–	11.2	–	ns
E_{on}	Turn−On Switching Loss		–	227	–	μJ
E_{off}	Turn−Off Switching Loss		–	100	–	μJ
E_{ts}	Total Switching Loss		–	327	–	μJ
$t_{d(on)}$	Turn−On Delay Time	V_{CC} = 400 V, I_C = 30 A, R_G = 4.7 Ω, V_{GE} = 15 V, Inductive Load, T_C = 25°C	–	21.6	–	ns
t_r	Rise Time		–	14.4	–	ns
$t_{d(off)}$	Turn−Off Delay Time		–	97.6	–	ns
t_f	Fall Time		–	4.8	–	ns
E_{on}	Turn−On Switching Loss		–	585	–	μJ
E_{off}	Turn−Off Switching Loss		–	167	–	μJ
E_{ts}	Total Switching Loss		–	752	–	μJ
$T_{d(on)}$	Turn−On Delay Time	V_{CC} = 400 V, I_C = 15 A, R_G = 4.7 Ω, V_{GE} = 15 V, Inductive Load, T_C = 175°C	–	19.2	–	ns
T_r	Rise Time		–	9.6	–	ns
$T_{d(off)}$	Turn−Off Delay Time		–	115	–	ns
T_f	Fall Time		–	11.2	–	ns
E_{on}	Turn−On Switching Loss		–	448	–	μJ
E_{off}	Turn−Off Switching Loss		–	199	–	μJ
E_{ts}	Total Switching Loss		–	647	–	μJ

ELECTRICAL CHARACTERISTICS OF THE IGBT (T_C = 25°C unless otherwise noted)

Symbol	Parameter	Test Conditions	Min	Typ	Max	Unit
SWITCHING CHARACTERISTICS						
$T_{d(on)}$	Turn−On Delay Time	V_{CC} = 400 V, I_C = 30 A, R_G = 4.7 Ω, V_{GE} = 15 V, Inductive Load, T_C = 175°C	–	20.8	–	ns
T_r	Rise Time		–	16	–	ns
$T_{d(off)}$	Turn−Off Delay Time		–	106	–	ns
T_f	Fall Time		–	8.8	–	ns
E_{on}	Turn−On Switching Loss		–	942	–	μJ
E_{off}	Turn−Off Switching Loss		–	386	–	μJ
E_{ts}	Total Switching Loss		–	1328	–	μJ
Q_g	Total Gate Charge	V_{CE} = 400 V, I_C = 60 A, V_{GE} = 15 V	–	79	–	nC
Q_{ge}	Gate to Emitter Charge		–	22	–	nC
Q_{gc}	Gate to Collector Charge		–	27	–	nC

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions.

ELECTRICAL CHARACTERISTICS OF THE DIODE (T_C = 25°C unless otherwise noted)

Symbol	Parameter	Test Conditions		Min	Typ	Max	Unit
V_{FM}	Diode Forward Voltage	I_F = 30 A	T_C = 25°C	–	2.3	2.7	V
			T_C = 175°C	–	1.9	–	
E_{rec}	Reverse Recovery Energy	I_F = 30 A, dI_F/dt = 200 A/μs	T_C = 175°C	–	50	–	μJ
T_{rr}	Diode Reverse Recovery Time		T_C = 25°C	–	34.6	–	ns
			T_C = 175°C	–	197	–	
Q_{rr}	Diode Reverse Recovery Charge		T_C = 25°C	–	58.6	–	nC
			T_C = 175°C	–	810	–	

TYPICAL CHARACTERISTICS

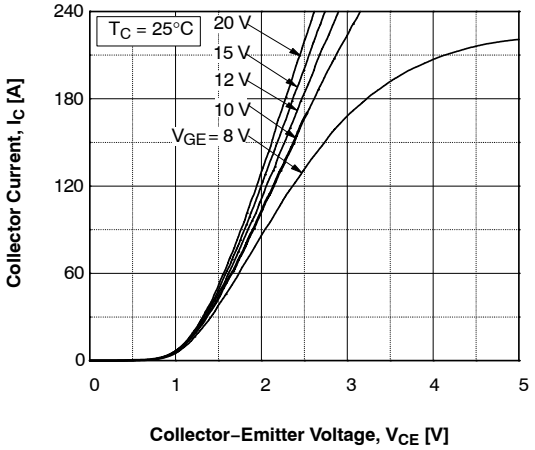


Figure 1. Typical Output Characteristics

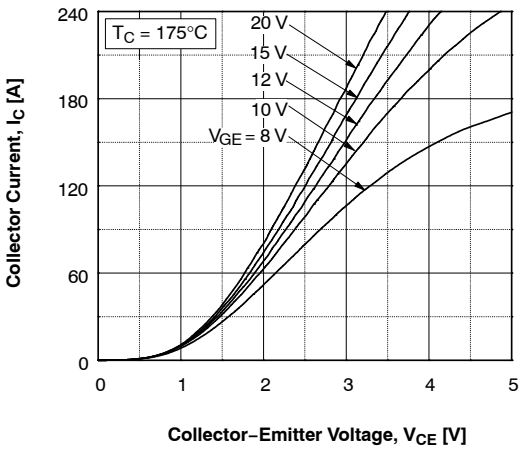


Figure 2. Typical Output Characteristics

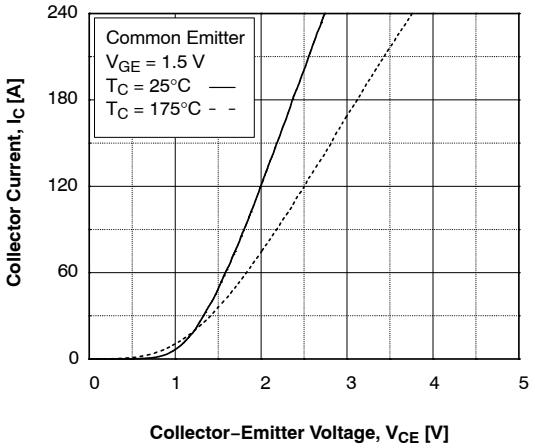


Figure 3. Typical Saturation Voltage Characteristics

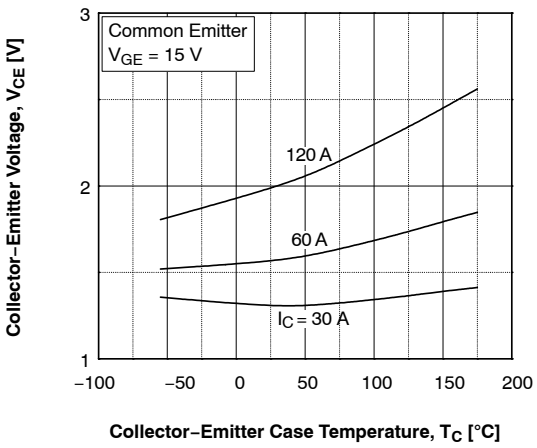


Figure 4. Saturation Voltage vs. Case Temperature at Variant Current Level

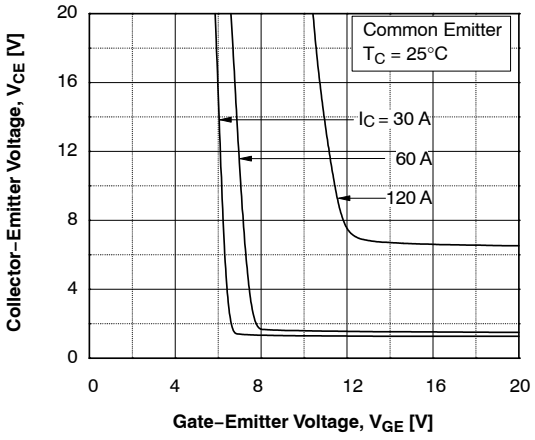


Figure 5. Saturation Voltage vs. V_{GE}

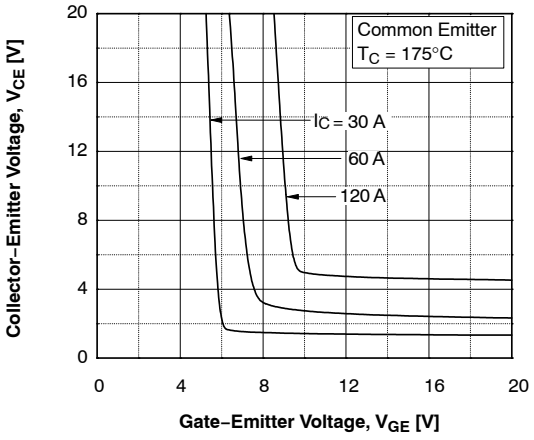


Figure 6. Saturation Voltage vs. V_{GE}

TYPICAL CHARACTERISTICS (Continued)

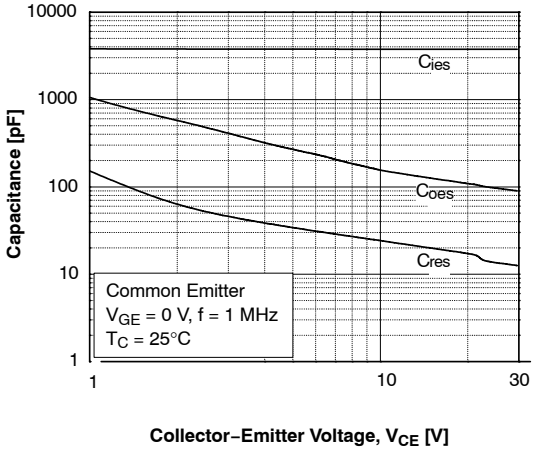


Figure 7. Capacitance Characteristics

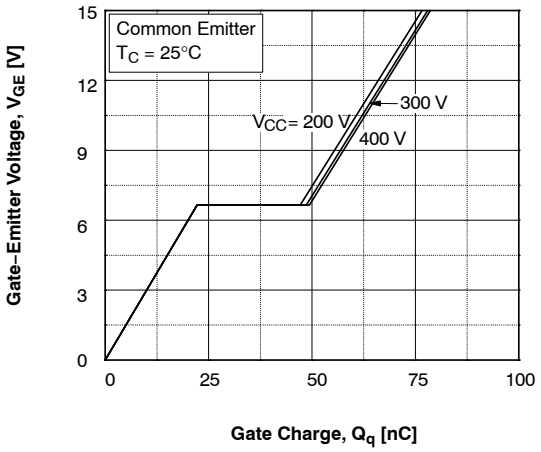


Figure 8. Gate Charge Characteristics

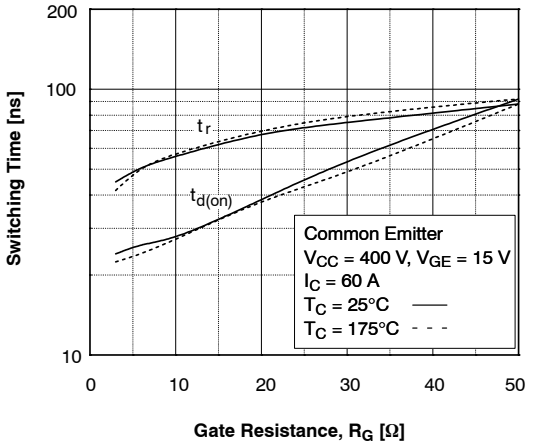


Figure 9. Turn−on Characteristics vs. Gate Resistance

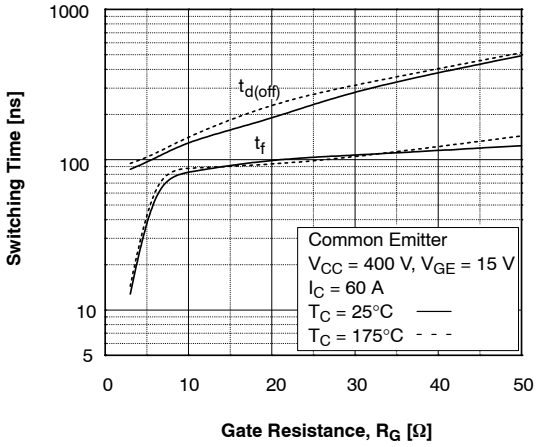


Figure 10. Turn−off Characteristics vs. Gate Resistance

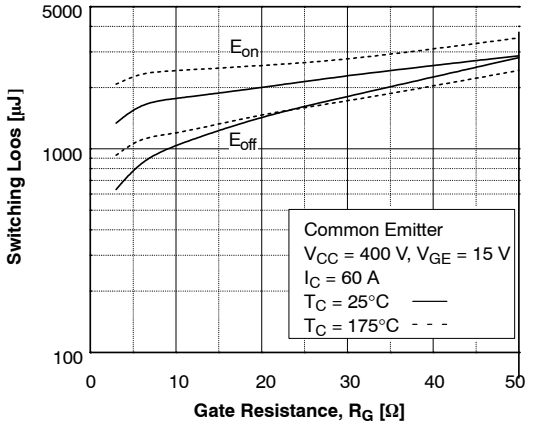


Figure 11. Switching Loos vs. Gate Resistance

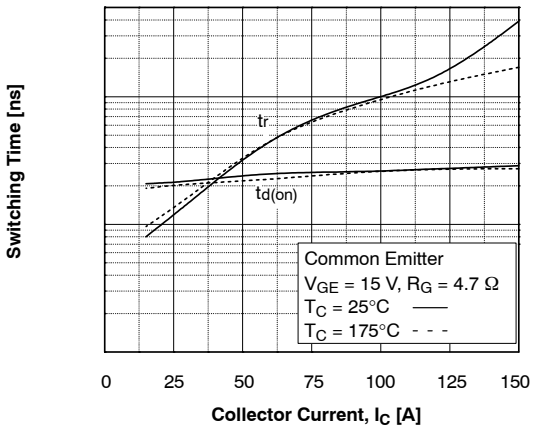


Figure 12. Turn−on Characteristics vs. Collector Current

TYPICAL CHARACTERISTICS (Continued)

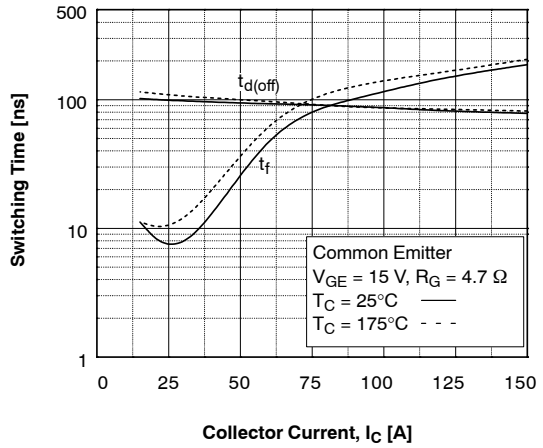


Figure 13. Turn−off Characteristics vs. Collector Current

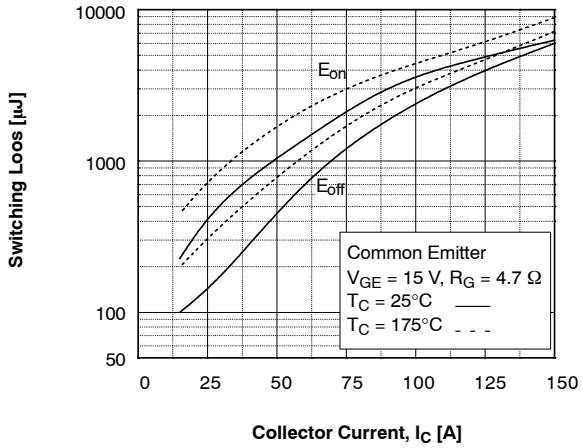


Figure 14. Switching Loos vs. Collector Current

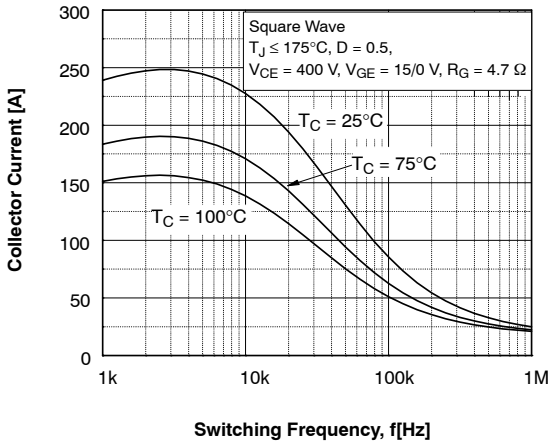


Figure 15. Load Current vs. Frequency

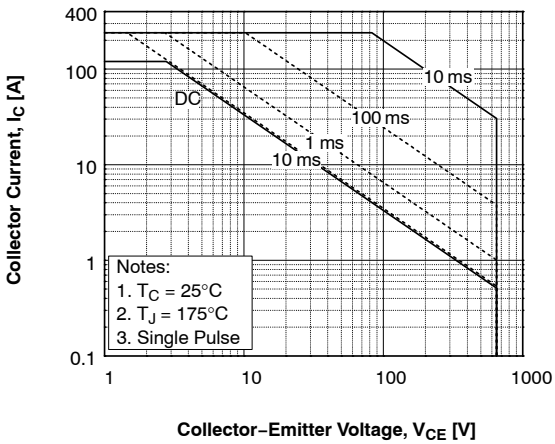


Figure 16. SOA Characteristics

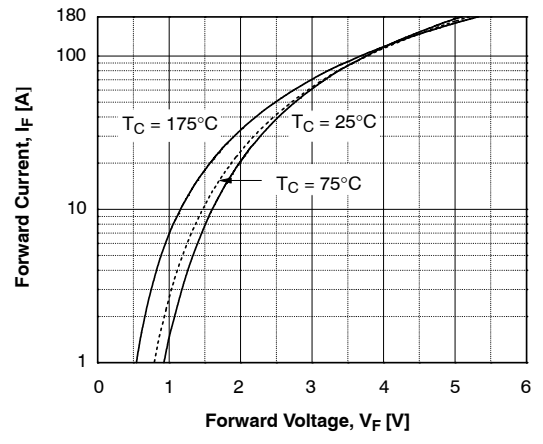


Figure 17. Forward Characteristics

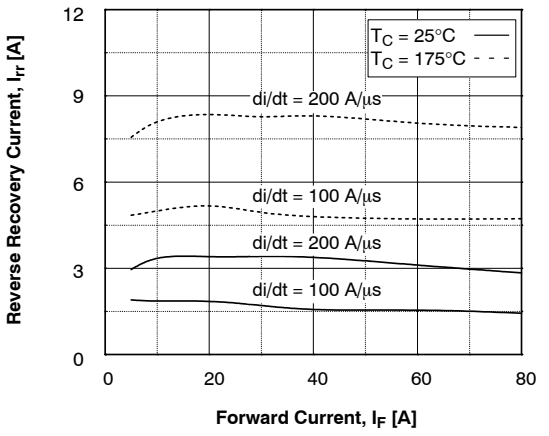


Figure 18. Reverse Recovery Current

TYPICAL CHARACTERISTICS (Continued)

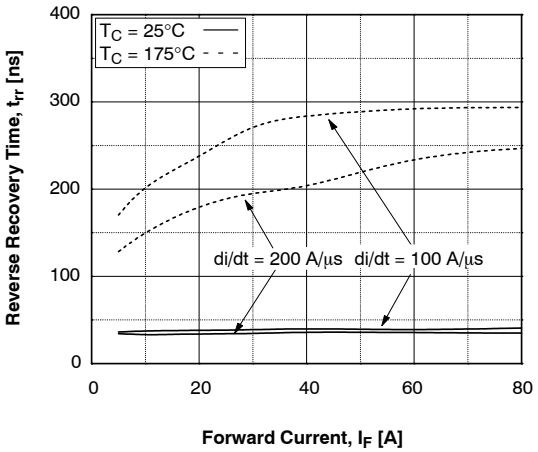


Figure 19. Reverse Recovery Time

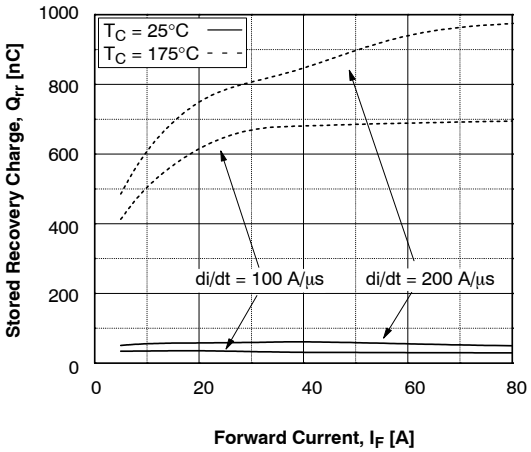


Figure 20. Stored Charge

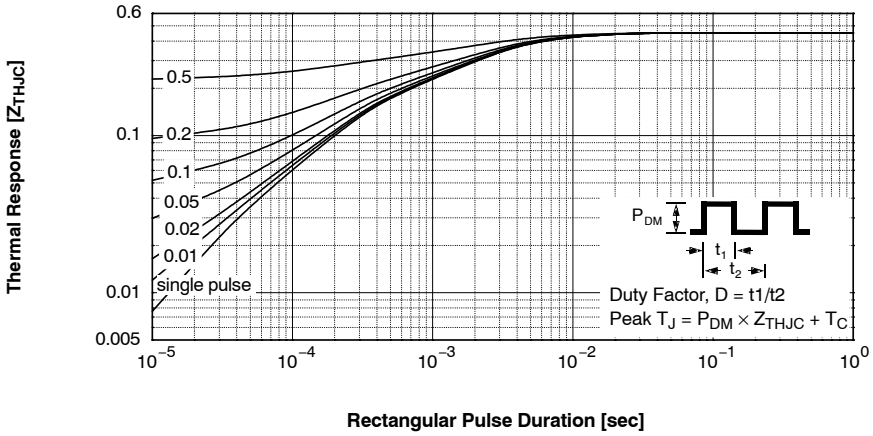


Figure 21. Transient Thermal Impedance of IGBT

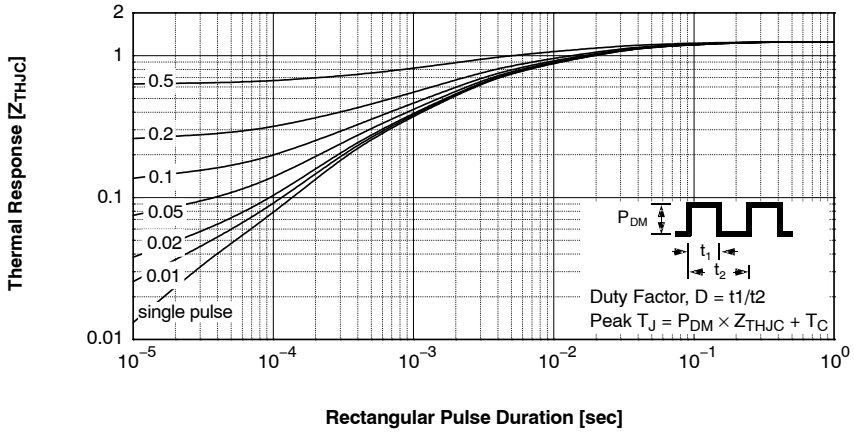


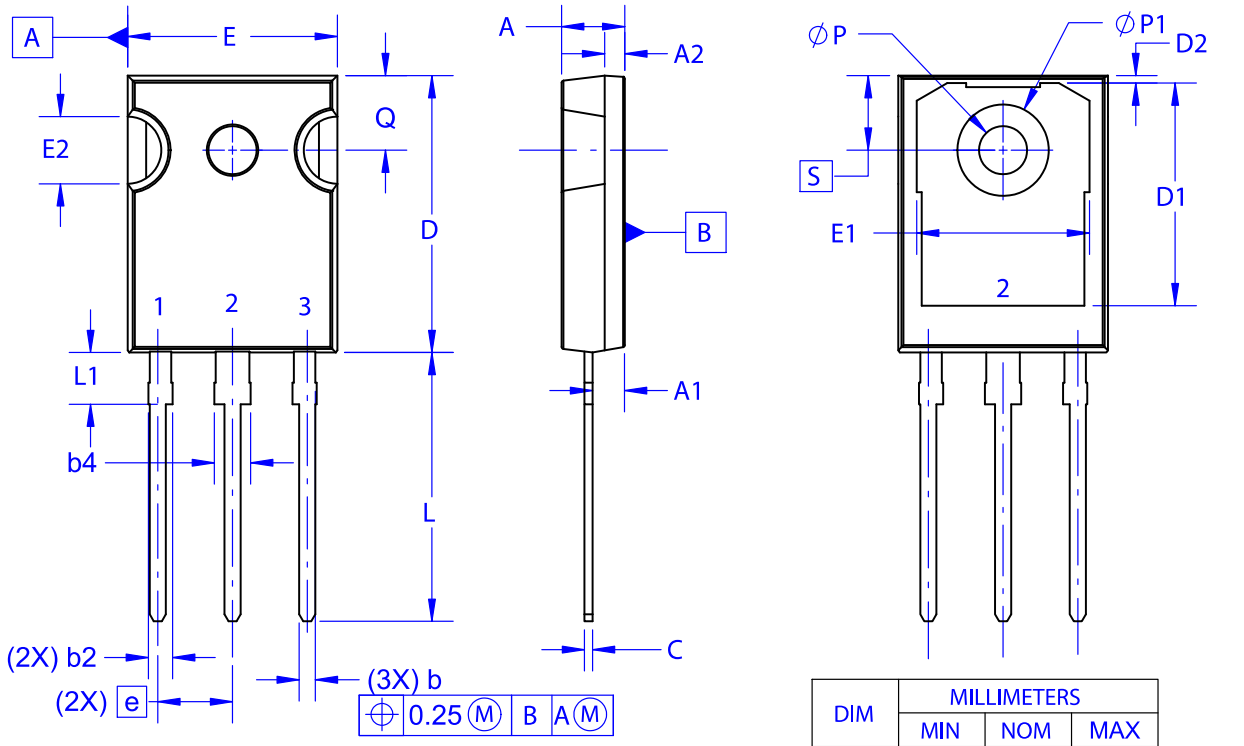
Figure 22. Transient Thermal Impedance of Diode

MECHANICAL CASE OUTLINE
PACKAGE DIMENSIONS

ON Semiconductor®

TO−247−3LD
CASE 340CH
ISSUE A

DATE 09 OCT 2019

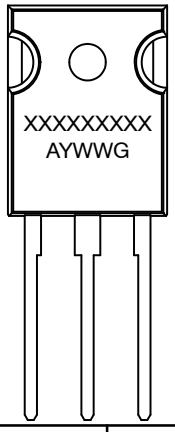


DIM	MILLIMETERS		
	MIN	NOM	MAX
A	4.58	4.70	4.82
A1	2.29	2.475	2.66
A2	1.40	1.50	1.60
D	20.32	20.57	20.82
E	15.37	15.62	15.87
E2	4.96	5.08	5.20
e	~	5.56	~
L	19.75	20.00	20.25
L1	3.69	3.81	3.93
ØP	3.51	3.58	3.65
Q	5.34	5.46	5.58
S	5.34	5.46	5.58
b	1.17	1.26	1.35
b2	1.53	1.65	1.77
b4	2.42	2.54	2.66
c	0.51	0.61	0.71
D1	13.08	~	~
D2	0.51	0.93	1.35
E1	12.81	~	~
ØP1	6.61	6.73	6.85

NOTES: UNLESS OTHERWISE SPECIFIED.

A. DIMENSIONS ARE EXCLUSIVE OF BURRS, MOLD FLASH, AND TIE BAR EXTRUSIONS.
B. ALL DIMENSIONS ARE IN MILLIMETERS.
C. DRAWING CONFORMS TO ASME Y14.5 - 2009.
D. DIMENSION A1 TO BE MEASURED IN THE REGION DEFINED BY L1.
E. LEAD FINISH IS UNCONTROLLED IN THE REGION DEFINED BY L1.

GENERIC
MARKING DIAGRAM*



XXXX = Specific Device Code
A = Assembly Location
Y = Year
WW = Work Week
G = Pb−Free Package

*This information is generic. Please refer to device data sheet for actual part marking. Pb−Free indicator, “G” or microdot “▪”, may or may not be present. Some products may not follow the Generic Marking.

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DESCRIPTION:	**TO−247−3LD**	**PAGE 1 OF 1**

PUBLICATION ORDERING INFORMATION

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Email Requests to: orderlit@onsemi.com

onsemi Website: www.onsemi.com

TECHNICAL SUPPORT
North American Technical Support:
Voice Mail: 1 800−282−9855 Toll Free USA/Canada
Phone: 011 421 33 790 2910

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